◇ STRUCTURE Silicon Monolithic Integrated Circuit

◇ PRODUCT SPI BUS 32Kbit (4,096×8bit) EEPROM

◇ PART NUMBER BR25L320-W Series

PART NUMBER	PACKAGE
BR25L320F-W	SOP8
BR25L320FJ-W	SOP-J8

◇ FEATURES
Serial Peripheral Interface
Single power supply (1.8V～5.5V)
1,000,000 erase/write cycles endurance

◇ ABSOLUTE MAXIMUM RATING (Ta=25℃)

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc	-0.3～6.5	V
Power Dissipation	Pd	450 (BR25L320F-W) *1	mW
		450 (BR25L320FJ-W) *2	
Storage Temperature	Tstg	-65～125	℃
Operating Temperature	Topr	-40～85	℃
Terminal Voltage	—	-0.3～Vcc+0.3	V

* Degradation is done at 4.5mW/℃(*1,2)for operation above 25℃

◇ RECOMMENDED OPERATING CONDITION

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc	1.8～5.5	V
Input Voltage	VIN	0～Vcc	V

Status of this document
The Japanese version of this document is the fomal specification.
A customer may use this translation version only for a reference to help reading the formal version.
If there are any differences in translation version of this document, formal version takes priority.

◇MEMORY CELL CHARACTERISTICS(Ta=25℃, Vcc=1.8～5.5V)

Parameter		Specification			Unit
		Min.	Typ.	Max.	
Write/Erase Cycle	*1	1,000,000	-	-	Cycle
Data Retention	*1	40	-	-	Year

○Initial Data : Memory array FFh, Status Register WPEN:0, BP1:0, BP0:0

*1 Not 100% TESTED

◇ DC OPERATING CHARACTERISTICS

(Unless otherwise specified Ta=−40～85℃, Vcc=1.8～5.5V)

Parameter	Symbol	Specification			Unit	test condition
		Min.	Typ.	Max.		
"H" Input Voltage1	VIH1	0.7xVcc	—	Vcc+0.3	V	1.8V≦Vcc≦5.5V
"L" Input Voltage1	VIL1	-0.3	—	0.3xVcc	V	1.8V≦Vcc≦5.5V
"L" Output Voltage1	VOL1	0	—	0.4	V	IOL=2.1mA (Vcc=2.5V～5.5V)
"L" Output Voltage2	VOL2	0	—	0.2	V	IOL=150μA (Vcc=1.8V～5.5V)
"H" Output Voltage1	VOH1	Vcc-0.5	—	Vcc	V	IOH=-0.4mA (Vcc=2.5V～5.5V)
"H" Output Voltage2	VOH2	Vcc-0.2	—	Vcc	V	IOH=-100μA (Vcc=1.8V～5.5V)
Input Leakage Current	ILI	-1	—	1	μA	VIN=0V～Vcc
Output Leakage Current	ILO	-1	—	1	μA	VOUT=0V～Vcc , CSB=Vcc
Operating Current Write	ICC1	—	—	1	mA	Vcc=1.8V , fSCK=2MHz , tE/W=5ms Byte Write, Page Write, Write Status Register
	ICC2	—	—	2	mA	Vcc=2.5V , fSCK=5MHz , tE/W=5ms Byte Write, Page Write, Write Status Register
	ICC3	—	—	3	mA	Vcc=5.5V , fSCK=5MHz , tE/W=5ms Byte Write, Page Write, Write Status Register
Operating Current Read	ICC4	—	—	1.5	mA	Vcc=2.5V , fSCK=5MHz Read, Read Status Register
	ICC5	—	—	2	mA	Vcc=5.5V , fSCK=5MHz Read, Read Status Register
Standby Current	ISB	—	—	2	μA	Vcc=5.5V $\overline{CS}$=$\overline{HOLD}$=$\overline{WP}$=Vcc SCK=SI=Vcc or GND, SO=OPEN

○This product is not designed for protection against radioactive rays.

◇ AC OPERATING CHARACTERISTICS

(Unless otherwise specified Ta=−40～85℃, C_L=100pF)

Parameter	Symbol	1.8V≦Vcc≦2.5V			2.5V≦Vcc≦5.5V			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
SCK clock Frequency	fSCK	—	—	2	—	—	5	MHz
SCK High Time	tSCKWH	200	—	—	85	—	—	ns
SCK Low Time	tSCKWL	200	—	—	85	—	—	ns
$\overline{CS}$ High Time	tCS	200	—	—	85	—	—	ns
$\overline{CS}$ Setup Time	tCSS	200	—	—	90	—	—	ns
$\overline{CS}$ Hold Time	tCSH	200	—	—	85	—	—	ns
SCK Setup Time	tSCKS	200	—	—	90	—	—	ns
SCK Hold Time	tSCKH	200	—	—	90	—	—	ns
SI Setup Time	tDIS	40	—	—	20	—	—	ns
SI Hold Time	tDIH	50	—	—	40	—	—	ns
Output Data Delay Time1	tPD1	—	—	150	-	—	70	ns
Output Data Delay Time2 (C_L=30pF)	tPD2	—	—	145	-	—	55	ns
Output Hold Time	tOH	0	—	—	0	—	—	ns
Output Disable Time	tOZ	—	—	250	-	—	100	ns
Clock High Setup Time before $\overline{HOLD}$ Active.	tHFS	120	—	—	60	—	—	ns
Clock Low Hold Time after $\overline{HOLD}$ Active.	tHFH	90	—	—	40	—	—	ns
Clock High Setup Time before $\overline{HOLD}$ not Active.	tHRS	120	—	—	60	—	—	ns
Clock Low Hold Time after $\overline{HOLD}$ not Active.	tHRH	140	—	—	70	—	—	ns
$\overline{HOLD}$ to Output High-Z	tHOZ	—	—	250	—	—	100	ns
$\overline{HOLD}$ to Output Valid	tHPD	—	—	150	—	—	70	ns
SCK Rise Time *1	tRC	—	—	1	—	—	1	μs
SCK Fall Time *1	tFC	—	—	1	—	—	1	μs
Output Rise Time *1	tRO	—	—	100	—	—	50	ns
Output Fall Time *1	tFO	—	—	100	—	—	50	ns
Write Cycle Time	tE/W	—	—	5	—	—	5	ms

*1 Not 100% TESTED

◇BLOCK DIAGRAM

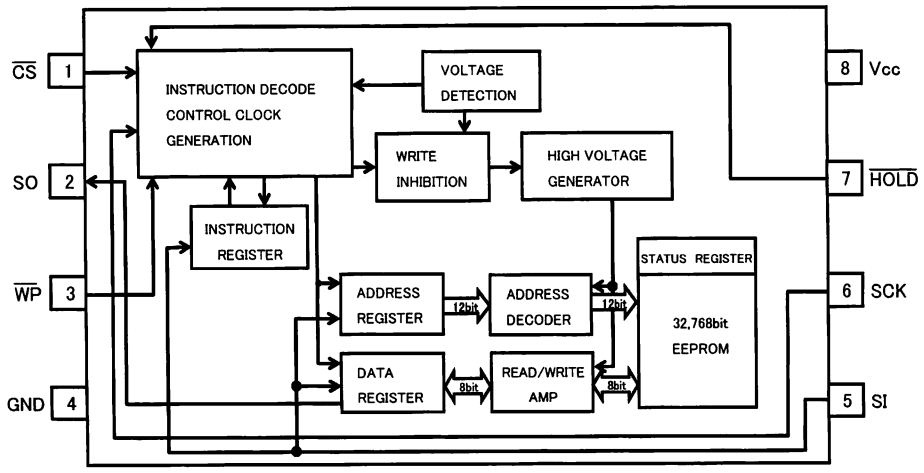

Fig.1 BLOCK DIAGRAM

◇ PIN No. / PIN NAME

PIN No.	PIN NAME
1	$\overline{CS}$
2	SO
3	$\overline{WP}$
4	GND
5	SI
6	SCK
7	$\overline{HOLD}$
8	Vcc

◇NOTES FOR POWER SUPPLY

In order to prevent an inadvertent write, the device has the feature of P.O.R.
After the power is on, the device is in the write disable mode. P.O.R. works only during power up. The noise may force the device write enable mode with $\overline{CS}$="H"during power ON/OFF. In the case of power up, keep the following conditions to ensure to make the function of P.O.R.

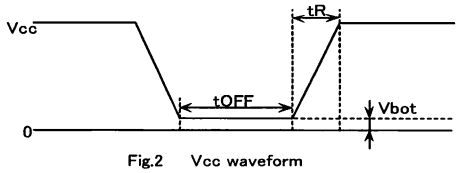

Fig.2 Vcc waveform

◇RECOMMENDED CONDITIONS OF tR, tOFF, Vbot

tR	tOFF	Vbot
Below 10ms	Above 10ms	Below 0.3V
Below 100ms	Above 10ms	Below 0.2V

Please keep $\overline{CS}$ "H" during power ON/OFF.
The device is an active state during $\overline{CS}$ is low. The extraordinary function or data collaption may occur because of noise etc., if power-up is done with $\overline{CS}$ "L". In order to prevent above errors from happening, keep $\overline{CS}$ "H" (=Vcc) during power ON. (The device does not receive any command during $\overline{CS}$ is high.)
It may continue at low Vcc by capacitance of Vcc line during power off.
Please keep $\overline{CS}$ "H" during power off because of the device may make malfunction and inadvertent write.

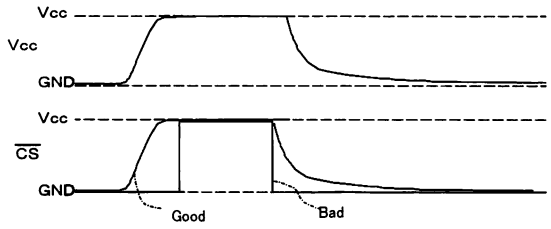

Fig.3 $\overline{CS}$ TIMING DURING POWER ON/OFF

(Good example)
$\overline{CS}$ follows Vcc. ($\overline{CS}$ is pull up to Vcc)

(Bad example)
$\overline{CS}$ is low during power ON/OFF.
Please take more than 10ms between power ON and power OFF, or the internal circuit is not always reset.

◇CAUTIONS ON USE

(1) Absolute maximum ratings
If the absolute maximum ratings such as impressed voltage and operating temperature range and so forth are exceeded, LSI may be destructed. Do not impress voltage and temperature exceeding the absolute maximum ratings. In the case of fear exceeding the absolute maximum ratings, take physical safety countermeasures such as fuses, and see to it that conditions exceeding the absolute maximum ratings should not be impressed to LSI.

(2) GND electric potential
Set the voltage of GND terminal lowest at any action condition. Make sure that each terminal voltages is lower than that of GND terminal.

(3) Heat design
In consideration of permissible dissipation in actual use condition, carry out heat design with sufficient margin.

(4) Terminal to terminal shortcircuit and wrong packaging
When to package LSI onto a board, pay sufficient attention to LSI direction and displacement. Wrong packaging may destruct LSI. And in the case of shortcircuit between LSI terminals and terminals and power source, terminal and GND owing to foreign matter, LSI may be destructed.

(5) Strong electromagnetic field
Use in a strong electromagnetic field may cause malfunction, therefore, evaluated design sufficiently.

◇PHYSICAL DIMENSION

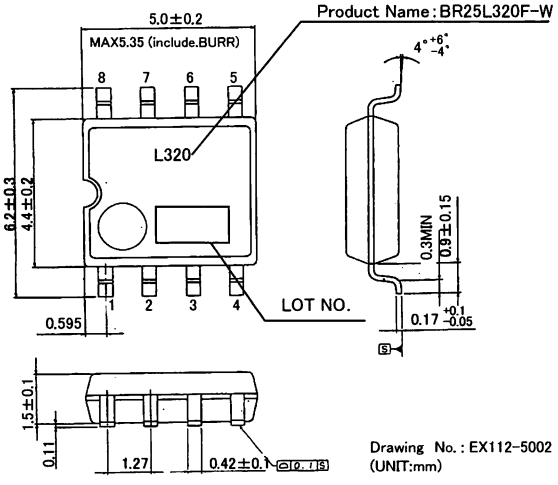

Fig4-(a) PHYSICAL DIMENSION
SOP-8 (BR25L320F-W)

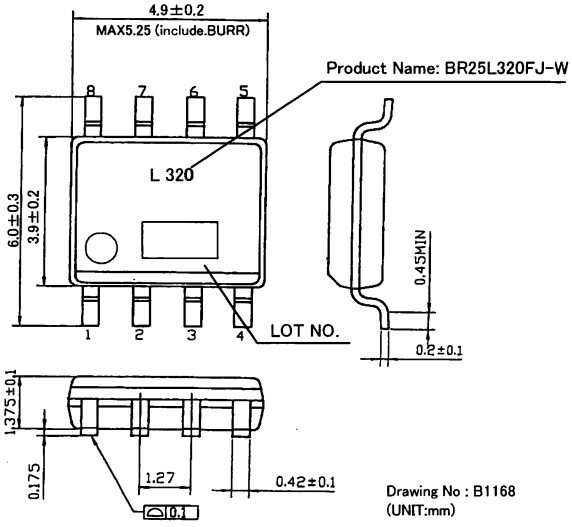

Fig-4(b) PHYSICAL DIMENSION
SOP-J8 (BR25L320FJ-W)

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U.S.A / San Diego	TEL : +1(858)625-3630	FAX : +1(858)625-3670
Atlanta	TEL : +1(770)754-5972	FAX : +1(770)754-0691
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Germany / Dusseldorf	TEL : +49(2154)9210	FAX : +49(2154)921400
United Kingdom / London	TEL : +44(1)908-282-666	FAX : +44(1)908-282-528
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Shanghai	TEL : +86(21)6279-2727	FAX : +86(21)6247-2066
Dilian	TEL : +86(411)8230-8549	FAX : +86(411)8230-8537
Beijing	TEL : +86(10)8525-2483	FAX : +86(10)8525-2489
Taiwan / Taipei	TEL : +866(2)2500-6956	FAX : +866(2)2503-2869
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Philippines / Manila	TEL : +63(2)807-6872	FAX : +63(2)809-1422
Thailand / Bangkok	TEL : +66(2)254-4890	FAX : +66(2)256-6334

Japan /
(Internal Sales)

Tokyo 2-1-1, Yaesu, Chuo-ku, Tokyo 104-0082
TEL : +81(3)5203-0321 FAX : +81(3)5203-0300

Yokohama 2-4-8, Shin Yokohama, Kohoku-ku, Yokohama, Kanagawa 222-8575
TEL : +81(45)476-2131 FAX : +81(45)476-2128

Nagoya Dainagayo Building 9F 3-28-12, Meieki, Nakamura-ku, Nagoya,Aichi 450-0002
TEL : +81(52)581-8521 FAX : +81(52)561-2173

Kyoto 579-32 Higashi Shiokouji-cho, Karasuma Nishi-iru, Shiokoujidori, Shimogyo-ku, Kyoto 600-8216
TEL : +81(75)311-2121 FAX : +81(75)314-6559

(Contact address for overseas customers in Japan)

Yokohama TEL : +81(45)476-9270 FAX : +81(045)476-9271

As of 18th. April 2005